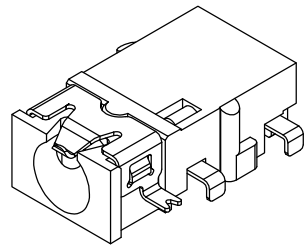
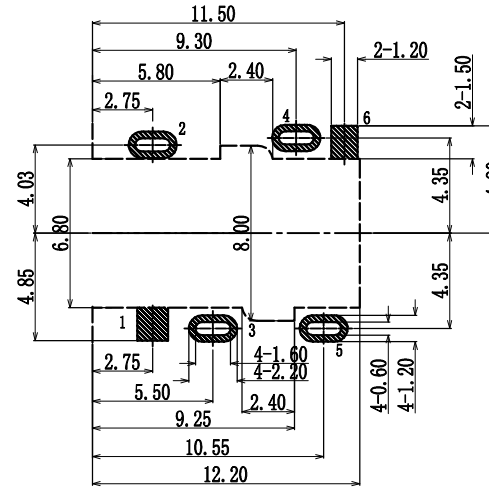
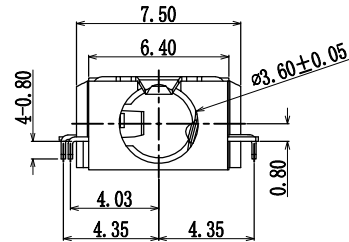
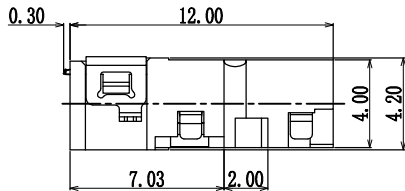
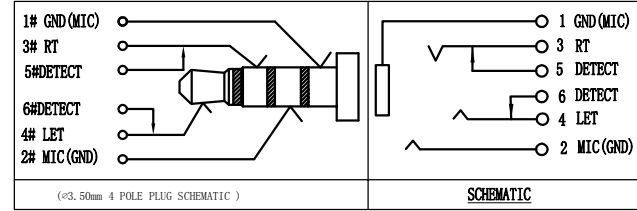
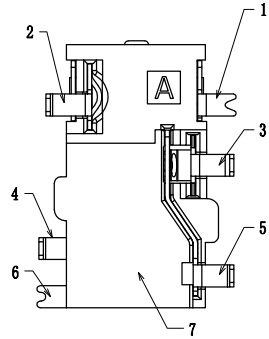


REV.	ECN. NO.	APPD.
A	/	/



3D VIEW



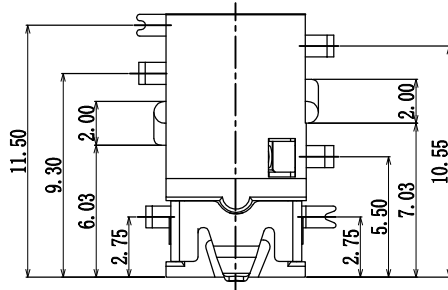
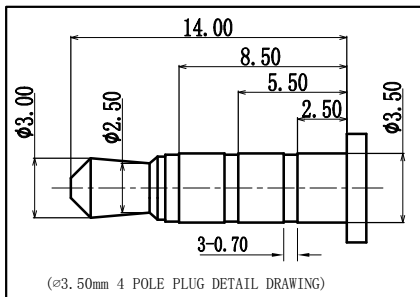
P.C.B LAYOUT  
TOP VIEW

NOTES:

- CONTACT CURRENT RATING: 1A.
- CONTACT RESISTANCE: 50 mΩ MAX. ;
- INSULATION RESISTANCE: 100MΩ MIN. ;
- DIELECTRIC WITHSTANDING: 500V AC MIN. ;
- DURABILITY: 5,000 CYCLES MIN. ;
- CONNECTOR MATING FORCES: 30N MAX. ;
- CONNECTOR UNMATING FORCES: 3N MIN. ;

JK1-158-XXX7

- 1: 半金1u"
- 3: 半金3u"
- 5: 半金5u"
- 8: 半金15u"
- 9: 镀全金1u"
- G: 半金G/Fu"
- 2: 吸塑管
- 7: 冷封载带
- 6: 载带+贴麦拉
- 8: 热封载带
- 1: 黑色
- 2: 白色
- 3: 米黄色
- 6: LCP
- 2: PBT



NO.	DESCRIPTION	MATERIAL	REMARK
7	HOUSING	HIGHT TEMPERATURE PLASTIC COLOR BLACK	
6	CONTACT 6#	STAINLESS STEEL; NICKEL UNDER PLATING OVERALL,GOLD FLASH ON SOLDER AREA	T=0.20mm
5	CONTACT 5#	STAINLESS STEEL; NICKEL UNDER PLATING OVERALL,GOLD FLASH ON SOLDER AREA	T=0.20mm
4	CONTACT 4#	COPPER ALLOY; NICKEL UNDER PLATING OVERALL,GOLD FLASH PLATING ON SOLDER AREA ;GOLD FLASH PLATING ON CONTACT AREA	T=0.20mm
3	CONTACT 3#	STAINLESS STEEL; NICKEL UNDER PLATING OVERALL,GOLD FLASH ON SOLDER AREA	T=0.20mm
2	CONTACT 2#	COPPER ALLOY; NICKEL UNDER PLATING OVERALL,GOLD FLASH PLATING ON SOLDER AREA ;GOLD FLASH PLATING ON CONTACT AREA	T=0.20mm
1	CONTACT 1#	STAINLESS STEEL; NICKEL UNDER PLATING OVERALL,GOLD FLASH ON OVERALL;	T=0.20mm

TOLERANCE UNLESS OTHERWISE SPECIFIED	
.XXX ±0.10	.X° ±3°
.XX ±0.20	.XX° ±2°
.X ±0.30	

**FLW** 深圳市华联威电子科技有限公司  
HUA LIAN WEI TECHNOLOGY ELECTRONICS CO;LTD.

APPROVED		PART NAME:	耳机沉板0.8			
CHECKED		PART No:	JK1-158-G217		C	
DRAWN	weihong	PROJECTION:	UNIT:	SCALE	SHEET	REV.
DATE	2021.9.23		mm	1:1	10F1	A